

MOLD FOR PRODUCING FILM-COATED FORMED COMPONENT AND METHOD
FOR TAKING OUT THE COMPONENT FROM THE MOLD BY FUSING

A B S T R A C T

A receiving device and a method are disclosed for safely taking out a film-coated formed component after it is trimmed by fusing wherein both edges of the residual outer part of the coating-film and the inner part of it do not
5 adhere to a fusing heat-emissive body (3). The method includes the steps of applying electricity to the electric heat-emissive body and fusing the coating-film of the component along the periphery of the component, separating an outer residual part of the fused coating-film from the heat-emissive body, separating the film of the film-coated formed component from the heat-emissive
10 body, and taking the fused film-coated formed component out of the receiving mold after stopping the electricity to the heat-emissive body.

Figure 1 to be used for publication.